

Report No. MCR-22-0294 April 26,2022

RENESAS SEMICONDUCTOR RELIABILITY REPORT

GROUP : RX13T

DEVICE : R5F513TXXX

APPLICATION: Consumer / Industry

Quality Assurance Div. Renesas Electronics Corporation



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Table. Reliability test results (QFP)

Test Items	Reference	Test Conditions	Results Failure/Size	Comment
High Temperature Operating Life (HTOL)	JESD22-A108	Ta=125 ℃, Vccmax, 1000 hrs	0/22	
High Temperature Storage Life (HTSL)	JESD22-A103	Ta=150 ℃, 1000 hrs	0/22	
Temperature Humidity bias (THB) (*1)	JESD22-A101	Ta=85 ℃, RH=85 %, Vccmax, 1000 hrs	0/22	
Temperature Cycling (TC) (*1)	JESD22-A104	Ta=-65 $℃$ to 150 $ℂ$, 300 cycles	0/22	
Latch-Up (LU)	JESD78	Pulse Current Injection, I=+/-150 mA	0/3	
Electrostatic discharge (ESD-HBM)	JS-001	1.5 kΩ, 100 pF, +/-2000 V, 1 time 0/3		Class: 2
Electrostatic discharge (ESD-CDM)	JEITA ED-4701/302	+/-1000V,1time	000V,1time 0/3	
Solderability (SD)		245 ℃, 5 s, Solder coverage ≥95 %	0/5	
Resistance to Soldering Heat (PC) *1) With preconditioning per JESD	JESD22-A113, J-STD-020	MSL3(Moisture Sensitivity Level 3)	0/22	

Basically qualification tests were performed using a representative product with the same wafer process and the same package structure .

^{*1)} With preconditioning per JESD22-A113, MSL 3
•It is tested to confirm that all the samples are satisfied with an individual product specification.



Table. Reliability test results (QFN)

Test Items	Reference	Test Conditions	Results Failure/Size	Comment
High Temperature Operating Life (HTOL)	JESD22-A108	Ta=125 ℃, Vccmax, 1000 hrs	0/22	
High Temperature Storage Life (HTSL)	JESD22-A103	Ta=150 ℃, 1000 hrs	0/22	
Temperature Humidity bias (THB) (*1)	JESD22-A101	Ta=85 ℃, RH=85 %, Vccmax, 1000 hrs	0/22	
Temperature Cycling (TC) (*1)	JESD22-A104	Ta=-65 $℃$ to 150 $ℂ$, 300 cycles	0/22	
Latch-Up (LU)	JESD78	Pulse Current Injection, I=+/-150 mA	0/3	
Electrostatic discharge (ESD-HBM)	JS-001	1.5 kΩ, 100 pF, +/-2000 V, 1 time 0/3		Class: 2
Electrostatic discharge (ESD-CDM)	JEITA ED-4701/302	7-1000V,1time 0/3		Class: Equivalent to C2b
Solderability (SD)	J-STD-002	245 ℃, 5 s, Solder coverage ≥95 %	0/5	
Resistance to Soldering Heat (PC)	JESD22-A113, J-STD-020	MSL3(Moisture Sensitivity Level 3)	0/22	

Basically qualification tests were performed using a representative product with the same wafer process and the same package structure .

^{*1)} With preconditioning per JESD22-A113, MSL 3
•It is tested to confirm that all the samples are satisfied with an individual product specification.

The failure rate of the device in an actual use condition can be estimated by the below procedure.

•Equation for the failure rate estimation (λ)

$$\lambda = \lambda b \times \pi T$$
 (FIT)

①Unique failure rate (λb)

$$\lambda b = 3.8 \text{ FIT}$$

Unique failure rate at Ta=55 ℃ using 60 % confidence level.

②Temperature term (π T)

$$\pi T = \exp\{11600 \times Ea \times (1/(273+55)-1/(273+Ta))\}$$

Ea: Activation energy (eV) Ta: Ambient temperature ($^{\circ}$ C)

$\pi T sim$	π T simplified chart as Ea=0.7 eV											
Ta (℃)	40	50	55	60	65	70	75	80	85	90	100	110
πΤ	0.31	0.68	1	1.45	2.08	2.95	4.15	5.77	7.96	10.88	19.82	34.99

·MTTF (Mean Time To Failure)

$$MTTF = 1/\lambda$$



Reference about Renesas package code

Package type	Package code *1	
Lead type plastic package	QFP	PxQP
Non-lead type plastic package	QFN	PxQN
Grid array type plastic package	BGA	PxBG
	LGA	PxLG

^{*1.} First four digit

Table. Product list

	e. Product li						
No	Group	Product part number	Package code	No	Group	Product part number	Package code
1	RX13T	R5F513T3ADFJ	PLQP0032G*	51			
2	RX13T	R5F513T3AGFJ	PLQP0032G*	52			
3	RX13T	R5F513T5ADFJ	PLQP0032G*	53			
4	RX13T	R5F513T5AGFJ	PLQP0032G*	54			
5	RX13T	R5F513T3ADFL	PLQP0048K*	55			
6	RX13T	R5F513T3AGFL	PLQP0048K*	56			
7	RX13T	R5F513T5ADFL	PLQP0048K*	57			
8	RX13T	R5F513T5AGFL	PLQP0048K*	58			
9	RX13T	R5F513T3ADNE	PWQN0048K*	59			
10	RX13T	R5F513T3AGNE	PWQN0048K*	60			
11	RX13T	R5F513T5ADNE	PWQN0048K*	61			
12	RX13T	R5F513T5AGNE	PWQN0048K*	62			
13	RX13T	R5F513T3ADNH	PWQN0032K*	63			
14	RX13T	R5F513T3AGNH	PWQN0032K*	64			
15	RX13T	R5F513T5ADNH	PWQN0032K*	65			
16	RX13T	R5F513T5AGNH	PWQN0032K*	66			
17	10(15)	INST STST ST CONT	1 11 Q11003211	67			
18				68			
19	†			69	1		
20				70			
21				71			
22				72			
23	1			73			
24	+			74	+	+	
	+						
25 26				75 76			
27				77			
28				78			
29				79			
30	<u> </u>			80	+		
31				81			
32				82			
33				83			
34				84			
35				85			
36				86			
37	1			87			
38	1			88			
39	1			89			
40				90			
41				91			
42				92			
43				93			
44				94			
45				95			
46				96			
47				97			
48				98			
49				99			
50				100			
JU			1	TOO			